### **Data Sheet**

# Incusil® - 25 - ABA

#### Description

High-purity Active Braze Alloy of silver, copper, indium and titanium developed for direct application to ceramic surfaces. Nominal composition by weight: **43.6% Ag. 29.1% Cu, 24.3% In** and **3Ti %** 

#### Prime features:

- Extremely low melting in the Ag-Cu-In family
- Allows ceramic-to-ceramic and ceramic-to-metal surfaces to be brazed without metallizing, firing and electroplating
- Cuts time and costs in manufacture of ceramic/metal assemblies

## **Typical Applications:**

• One step bonding to ceramics

## Suggested base materials:

 Copper, Kovar, Nickel, Carbon/ low alloy & Tool/high speed steel, Stainless steel, Ni-super alloys, Titanium, Refractory metals, Ceramics, Graphite, Diamond, Tungsten Carbide

## Physical Properties\*

| Liquidus Temperature                   | 612 °C                  |
|--|-------------------------|
|  | 1134 °F                 |
| Solidus Temperature                    | 488 °C                  |
|  | 910 °F                  |
| Coefficient of Thermal Expansion (CTE) |                         |
|  |                         |
| Thermal Conductivity (Calculated)      |                         |
|  |                         |
| Density                                |                         |
|  |                         |
| Yield Strength (0.2% offset)           |                         |
|  |                         |
| Tensile Strength                       |                         |
|  |                         |
| Elongation (2in/50mm gage section)     |                         |
| Electrical Resistivity                 |                         |
| Electrical Conductivity                |                         |
| Vapor Pressure (Calculated)            |                         |
|  |                         |
| Recommended Brazing Temperatures       |                         |
| Recommended Brazing Atmospheres        | 10⁻⁵ mm Hg or inert gas |
|  |                         |

<sup>\*</sup> Please note that all values quoted are based on test pieces and may vary according to component design. These values are not guaranteed in any way and should only be treated as indicative values. They should be used for guidance only and for no other purpose whatsoever.

### Impurity Limits

| Zn | less than 0.001% |
|----|------------------|
| Cd | less than 0.001% |
| РЬ | less than 0.002% |
| Р  | less than 0.002% |
| С  | less than 0.01%  |

All other metallic impurities having a vapor pressure higher than  $10^7$  mm Hg at 500 °C are limited to 0.002% each. Impurities having a vapor pressure lower than  $10^7$  mm Hg at 500 °C are limited to a total of 0.075%. (This applies to all forms except powder and extrudable paste.)

#### Supplied as:

Powder

The determination as to the adaptability of any Wesgo materials to the specific needs of the Buyer is solely the Buyer's prerogative and responsibility. All technical information, data and recommendations are based on tests and accumulated experience data, which Wesgo believed to be reliable. However, the accuracy and completeness thereof are not guaranteed.